



Mini-Circuits®

CERAMIC

Power Splitter/Combiner **SCG-2-242AT+**

2 Way-0° 50Ω 1000 to 2400 MHz

FEATURES

- Isolation resistor, external 100 ohms
- Low insertion loss, 0.8 dB typ.
- Excellent amplitude unbalance, 0.1 dB typ.
- Excellent phase unbalance, 1.5 deg. typ.
- High isolation, 15 dB typ.
- ESD non-sensitive
- Temperature stable LTCC technology
- Wrap around terminations for excellent solderability
- Low cost
- AEC-Q200 qualified component family



Generic photo used for illustration purposes only

CASE STYLE: GE0805C-1

+RoHS CompliantThe +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Automotive

ELECTRICAL SPECIFICATIONS¹ AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		1000		2400	MHz
Insertion Loss, above 3.0 dB	1000 - 2400	—	0.8	1.3	dB
Isolation	1000 - 2400	9	15	—	dB
Phase Unbalance	1000 - 2400	—	1.5	5.0	Degree
Amplitude Unbalance	1000 - 2400	—	0.1	0.3	dB
Return Loss (Input)	1000 - 2400	—	16	—	dB
Return Loss (Output)	1000 - 2400	—	20	—	dB

1. Tested on TB-1043+ using SCG-2-242+ with evaluation board losses de-embedded.

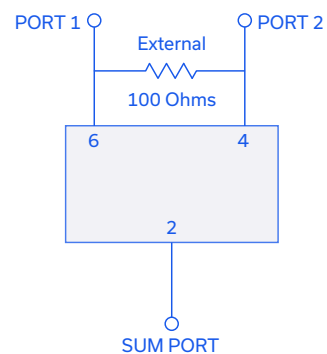
ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +105°C
Storage Temperature	-40°C to +105°C
Power Input (as a splitter)*	2 W max.

* Derate linearly to 0.7 W at +105°C ambient, power input as combiner is limited by the rating of the 100Ω external resistors.

Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



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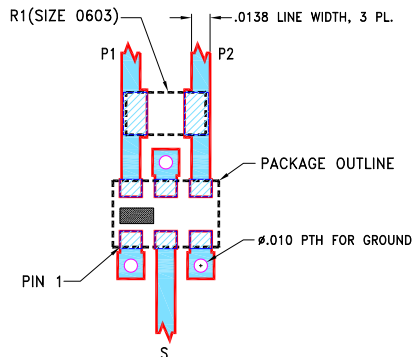
2 Way-0° 50Ω 1000 to 2400 MHz

PAD CONNECTIONS

SUM PORT	2
PORT 1	6
PORT 2	4
GROUND	1,3,5
PORT 1-2	100Ω External Resistor

PRODUCT MARKING: PB

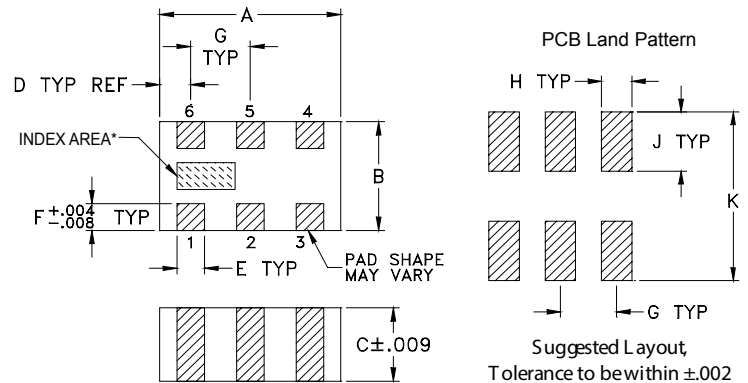
DEMO BOARD MCL P/N: TB-1043+
SUGGESTED PCB LAYOUT (PL-560)



NOTES:

1. LINE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS LINE WIDTH MAY NEED TO BE MODIFIED.
 2. UNIT FOOT PRINT IS OPTIMIZED FOR PERFORMANCE AND IS DIFFERENT FROM CASE STYLE GE0805C-1 RECOMMENDATIONS.
 3. CHIP COMPONENT FOOT PRINT IS SHOWN FOR REFERENCE. FOR COMPONENT VALUE REFER TO TB-1043+.
 4. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DRAWING



*Shape of index marking may vary

OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.079	.049	.033	.014	.012	.012
2.01	1.24	0.84	0.36	0.30	0.30
G	H	J	K	wt	
.026	.014	.039	.110	grams	
0.66	0.36	1.00	2.80	.008	

TAPE & REEL INFORMATION: F74





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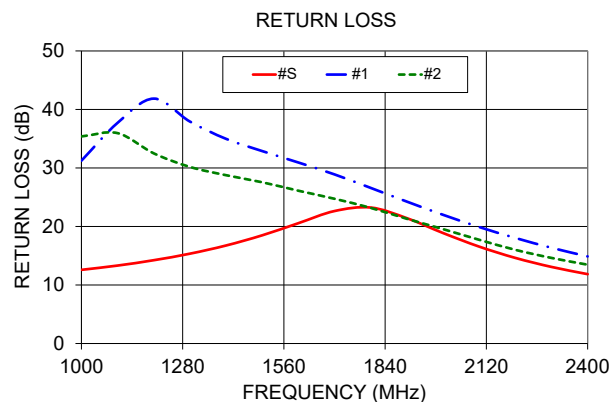
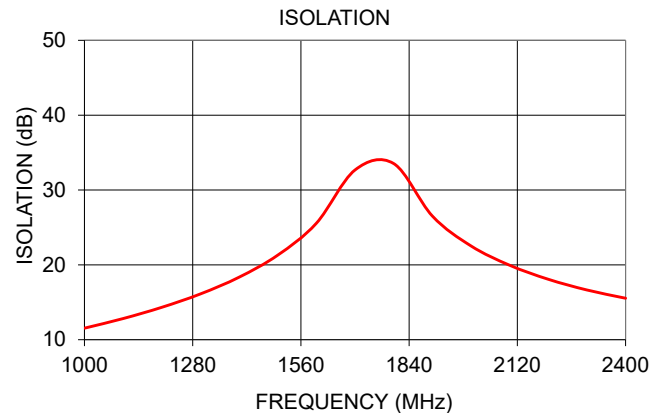
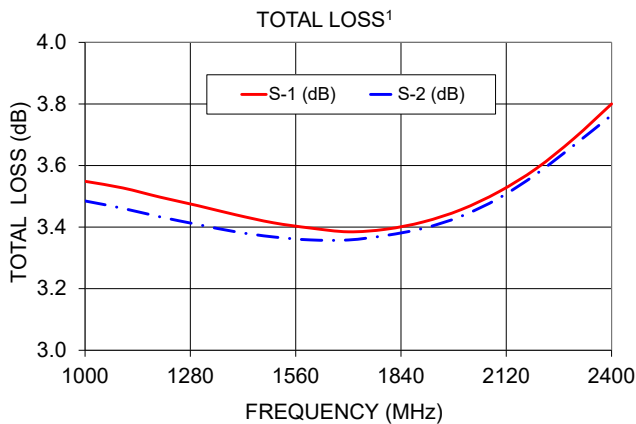
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2 Way-0° 50Ω 1000 to 2400 MHz

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Total Loss ¹ (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	Return Loss (dB)		
	S-1	S-2				S	1	2
1000	3.55	3.48	0.06	11.54	0.97	12.59	31.25	35.39
1100	3.53	3.46	0.07	12.82	1.08	13.32	37.71	35.95
1200	3.50	3.43	0.06	14.33	1.15	14.24	41.85	32.50
1300	3.47	3.41	0.06	16.11	1.23	15.35	37.93	30.18
1400	3.44	3.38	0.06	18.35	1.22	16.75	34.98	28.76
1500	3.41	3.37	0.05	21.30	1.28	18.49	32.88	27.55
1600	3.40	3.36	0.04	25.56	1.32	20.56	30.93	26.11
1700	3.38	3.36	0.03	32.68	1.39	22.64	28.90	24.73
1800	3.39	3.37	0.02	33.53	1.38	23.24	26.59	23.18
1900	3.42	3.40	0.02	26.53	1.39	21.42	24.25	21.31
2000	3.46	3.44	0.02	22.53	1.37	18.88	22.00	19.55
2100	3.51	3.49	0.02	19.95	1.55	16.56	19.91	17.72
2200	3.59	3.57	0.02	18.07	1.70	14.63	18.04	16.01
2300	3.69	3.67	0.02	16.64	1.77	13.09	16.36	14.63
2400	3.80	3.76	0.04	15.54	1.89	11.85	14.88	13.47

1. Total Loss = Insertion Loss + 3 dB splitter loss.



- NOTES**
- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

